

## PATENT ASSIGNMENT COVER SHEET

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<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
CHENGLING LV	06/23/2014
YAJUN YU	06/23/2014
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SHENZHEN CHINA STAR OPTOELECTRONICS TECHNOLOGY CO., LTD.
<b>Street Address:</b>	NO.9-2, TANGMING RD, GUANGMING
<b>City:</b>	SHENZHEN CITY, GUANGDONG
<b>State/Country:</b>	CHINA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	14369682
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<b>DATE SIGNED:</b>	06/27/2014
<b>Total Attachments: 2</b>	
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### ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1st Name: LV, Chengling  
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2nd Name: YU, Yajun  
Residing at: No.9-2, Tangming Road, Guangming, Shenzhen, Guangdong, 518132, China.

hereby Under an Obligation to sell, assign and transfer unto:

SHENZHEN CHINA STAR OPTOELECTRONICS TECHNOLOGY CO., LTD. of  
SHENZHEN, GUANGDONG, CHINA (hereinafter referred as "ASSIGNEE"), its successors  
and assigns, the entire right, title and interest in and to the invention known as  
BACKLIGHT MODULES, LIQUID CRYSTAL DEVICES, AND OLED DISPLAY DEVICES  
(hereinafter referred as "INVENTION"), for which a United States Patent Application was  
executed concurrently herewith or, if not so executed, was:

- a. ☐ executed on \_\_\_\_\_;
- b. ☐ filed on \_\_\_\_\_, Application Serial No. \_\_\_\_\_; or
- c. ☒ established by PCT International Patent Application No. PCT/CN2014/079839

an application for Letters Patent of United States of America.

The undersigned agree(s) to execute all papers necessary in connection with this application for patent in the USPTO for the invention, and any continuation, divisional or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any post-grant proceeding which may occur in connection with this application or continuation, divisional or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such post-grant proceeding.

The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

Signature of  
1st Inventor Lu, Chengling Executed Date 2014.6.23

Signature of  
2nd Inventor Yu, Yajun Executed Date 2014.6.23